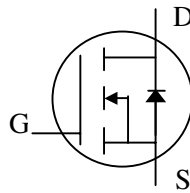




**N-channel Enhancement-mode Power MOSFET**

- Simple Drive Requirement**
- Low Gate Charge**
- Fast Switching Performance**
- RoHS-compliant, halogen-free**



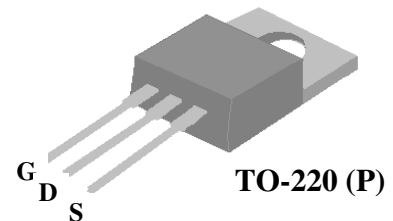
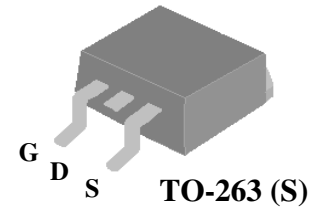
$BV_{DS}$	30V
$R_{DS(ON)}$	4m $\Omega$
$I_D$	80A

**Description**

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, low on-resistance and cost-effectiveness.

The AP92T03GS-HF-3 is in the TO-263 package, which is widely used for commercial and industrial surface-mount applications, and is well suited for low voltage applications such as DC/DC converters.

The AP92T03GP-HF-3 is in the TO-220 through-hole package which is used where a small PCB footprint or an attached heatsink is required.



**Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$ at $T_C=25^\circ\text{C}$	Continuous Drain Current	80	A
$I_D$ at $T_C=100^\circ\text{C}$	Continuous Drain Current	50	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	320	A
$P_D$ at $T_C=25^\circ\text{C}$	Total Power Dissipation	89	W
	Linear Derating Factor	0.71	W/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

**Thermal Data**

Symbol	Parameter	Value	Units
Rthj-c	Maximum Thermal Resistance, Junction-case	1.4	$^\circ\text{C}/\text{W}$
Rthj-a	Maximum Thermal Resistance, Junction-ambient (PCB mount) <sup>4</sup>	40	$^\circ\text{C}/\text{W}$
Rthj-a	Maximum Thermal Resistance, Junction-ambient	62	$^\circ\text{C}/\text{W}$

**Ordering Information**

**AP92T03GS-HF-3TR**    **RoHS-compliant TO-263, shipped on tape and reel (800 pcs/reel)**

**AP92T03GP-HF-3TB**    **RoHS-compliant TO-220, shipped in tubes**



**Electrical Specifications at  $T_j=25^\circ\text{C}$  (unless otherwise specified)**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=40A$	-	-	4	$m\Omega$
		$V_{GS}=4.5V, I_D=30A$	-	-	5.2	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.5	-	2	V
$g_{fs}$		$V_{DS}=10V, I_D=40A$	-	100	-	S
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=24V, V_{GS}=0V$	-	-	1	$\mu A$
	Drain-Source Leakage Current ( $T_j=125^\circ\text{C}$ )	$V_{DS}=24V, V_{GS}=0V$	-	-	250	$\mu A$
$I_{GSS}$	Gate-Source Leakage	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
$Q_g$	Total Gate Charge <sup>2</sup>	$I_D=40A$	-	45	72	nC
$Q_{gs}$	Gate-Source Charge	$V_{DS}=20V$	-	6	-	nC
$Q_{gd}$	Gate-Drain ("Miller") Charge	$V_{GS}=4.5V$	-	26	-	nC
$t_{d(on)}$	Turn-on Delay Time <sup>2</sup>	$V_{DS}=15V$	-	12	-	ns
$t_r$	Rise Time	$I_D=40A$	-	63	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=1\Omega, V_{GS}=10V$	-	40	-	ns
$t_f$	Fall Time	$R_D=0.375\Omega$	-	7	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0V$	-	3500	5600	pF
$C_{oss}$	Output Capacitance	$V_{DS}=25V$	-	930	-	pF
$C_{rss}$	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	770	-	pF

**Source-Drain Diode**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{SD}$	Forward On Voltage <sup>2</sup>	$I_S=40A, V_{GS}=0V$	-	-	1.3	V
$t_{rr}$	Reverse Recovery Time <sup>2</sup>	$I_S=20A, V_{GS}=0V,$	-	39	-	ns
$Q_{rr}$	Reverse Recovery Charge	$di/dt=100A/\mu s$	-	42	-	nC

**Notes:**

1. Pulse width limited by maximum junction temperature.
2. Pulse test
3. Package limitation current is 80A .
4. Surface mounted on 1 in<sup>2</sup> copper pad of FR4 board

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

APEC DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

APEC RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN.



Typical Electrical Characteristics

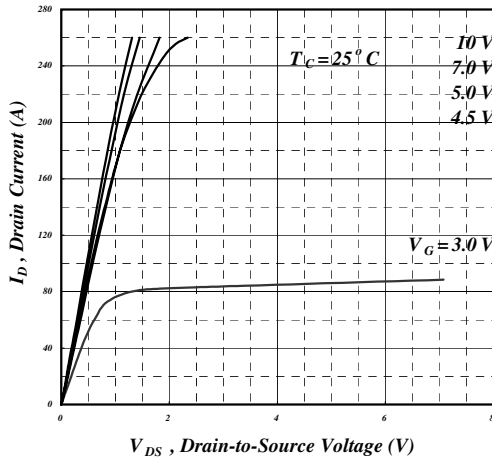


Fig 1. Typical Output Characteristics

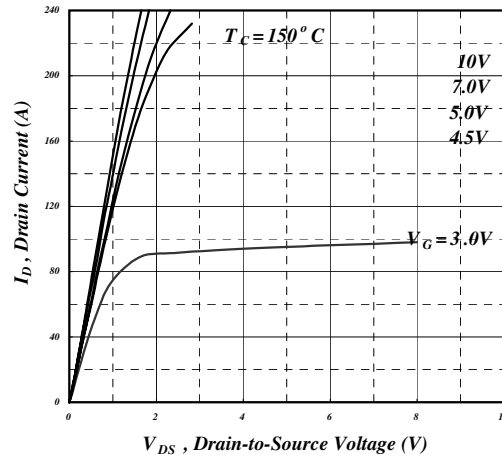


Fig 2. Typical Output Characteristics

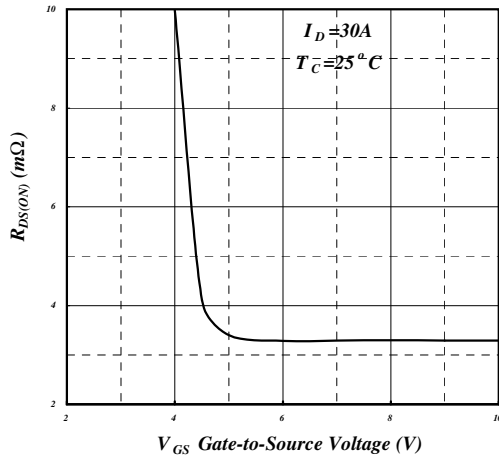


Fig 3. On-Resistance vs. Gate Voltage

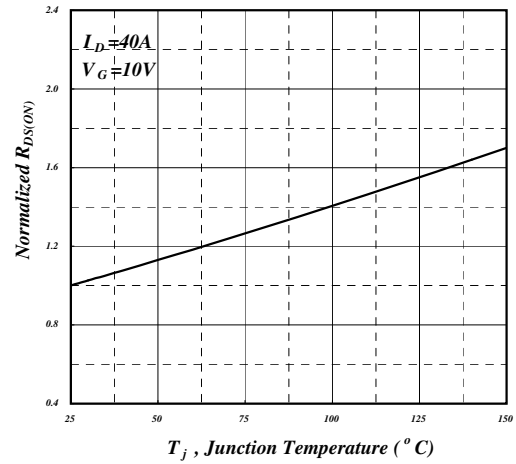


Fig 4. Normalized On-Resistance vs. Junction Temperature

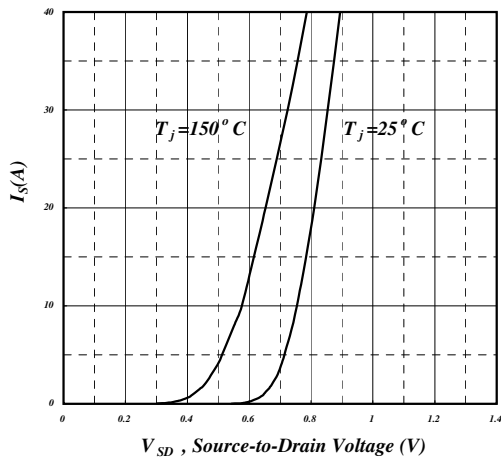


Fig 5. Forward Characteristic of Reverse Diode

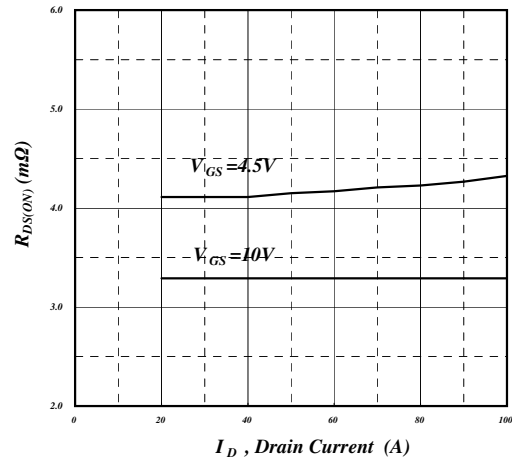


Fig 6. Gate Threshold Voltage vs. Junction Temperature



Typical Electrical Characteristics (cont.)

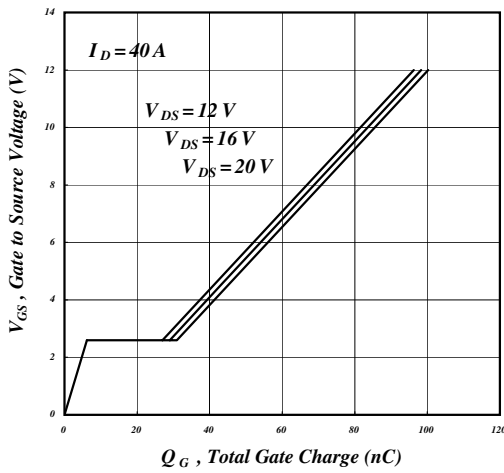


Fig 7. Gate Charge Characteristics

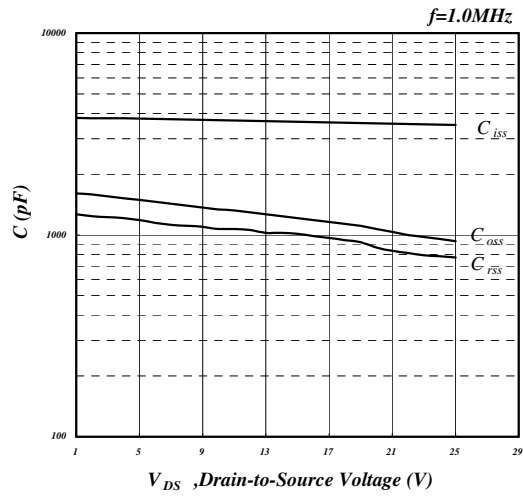


Fig 8. Typical Capacitance Characteristics

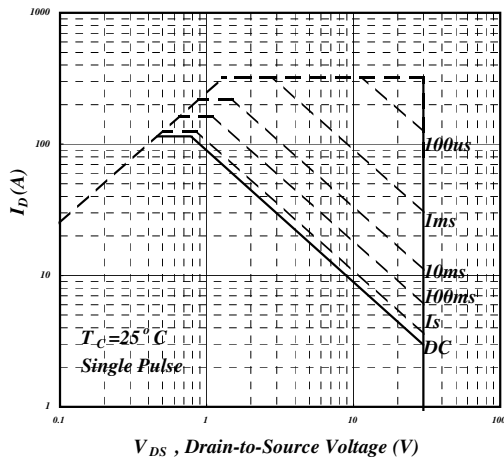


Fig 9. Maximum Safe Operating Area

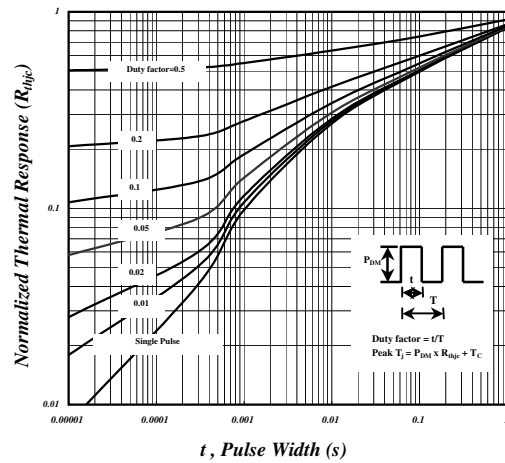


Fig 10. Effective Transient Thermal Impedance

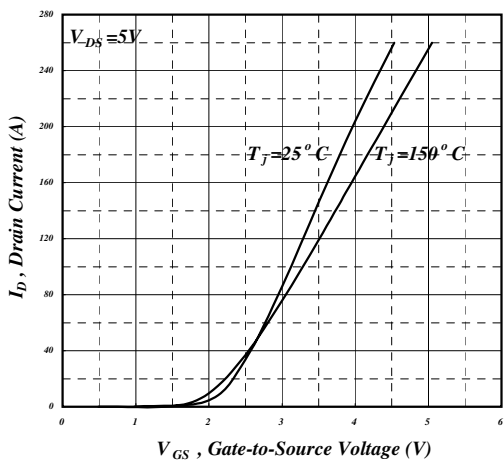


Fig 11. Transfer Characteristics

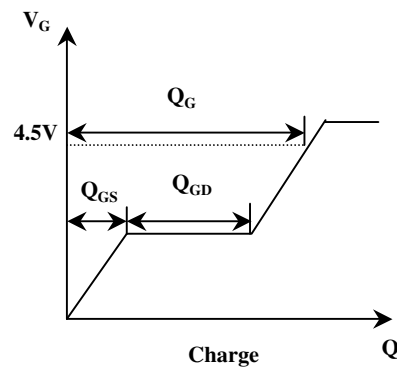
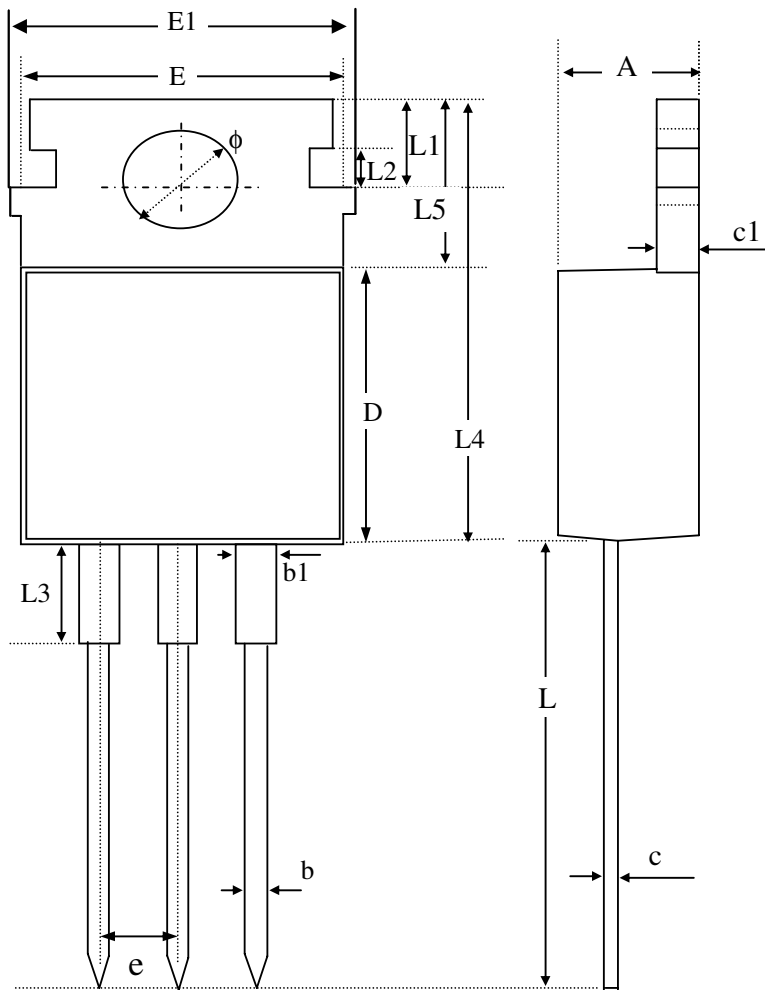


Fig 12. Gate Charge Waveform



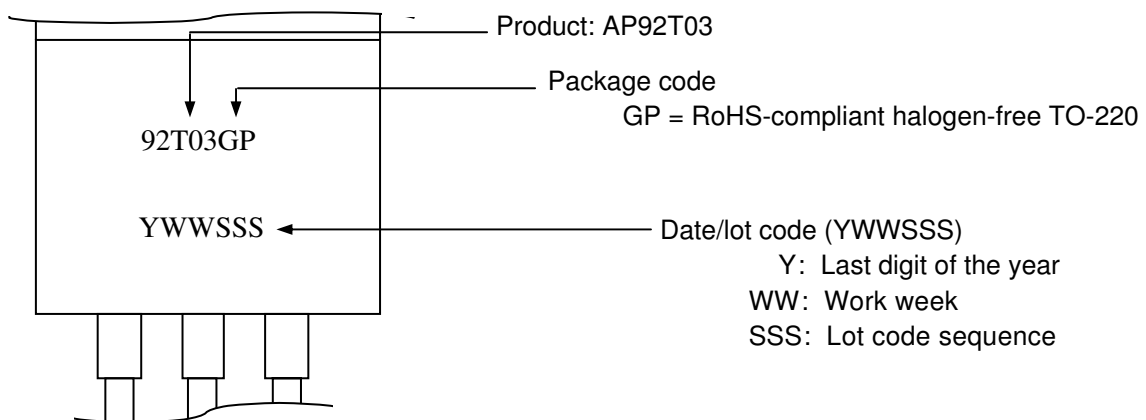
**Package Dimensions: TO-220**



SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	4.25	4.48	4.70
b	0.65	0.80	0.90
b1	1.15	1.38	1.60
c	0.40	0.50	0.60
c1	1.00	1.20	1.40
E	9.70	10.00	10.40
E1	---	---	11.50
e	----	2.54	----
L	12.70	13.60	14.50
L1	2.60	2.80	3.00
L2	1.00	1.40	1.80
L3	2.6	3.10	3.6
L4	14.70	15.50	16
L5	6.30	6.50	6.70
φ	3.50	3.60	3.70
D	8.40	8.90	9.40

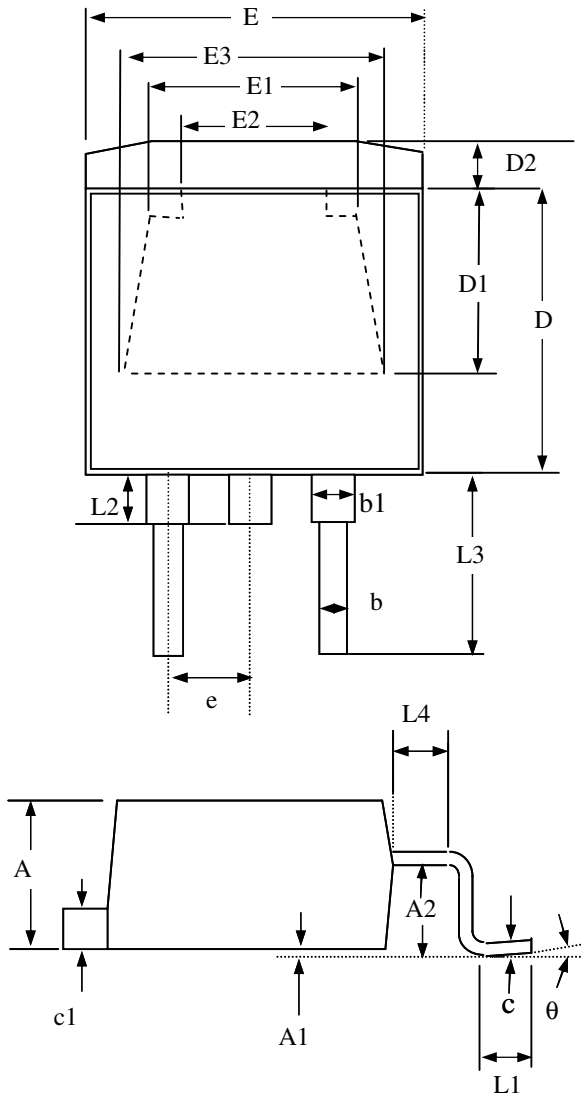
1. All dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

**Marking Information: TO-220**





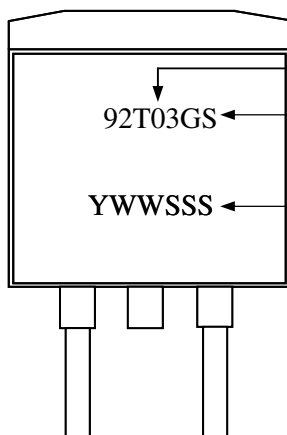
**Package Dimensions: TO-263**



SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	4.25	4.75	5.20
A1	0.00	0.15	0.30
A2	2.20	2.45	2.70
b	0.70	0.90	1.10
b1	1.07	1.27	1.47
c	0.30	0.45	0.60
c1	1.15	1.30	1.45
D	8.30	8.90	9.40
D1	5.10(ref)		
D2	1.27(ref)		
E	9.70	10.10	10.50
E1	7.40(ref)		
E2	6.40(ref)		
E3	8.00(ref)		
e	2.04	2.54	3.04
L1	2.54(ref)		
L2	1.50		
L3	4.50	4.90	5.30
L4	1.50		
$\theta$	0°	-----	5°

1. All dimensions are in millimeters.
2. Dimensions do not include mold protrusions.

**Marking Information: TO-263**



Product: AP92T03  
 Package code:  
 GS = RoHS-compliant halogen-free TO-263  
 Date Code (YWWSSS)  
 Y : Last digit of the year  
 WW : Work week  
 SSS : Lot code sequence